

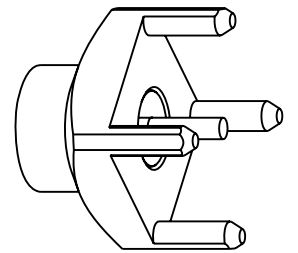
NOTES:

1. MATERIAL AND FINISH (PLATING THICKNESS IN INCHES):
 BODY - BRASS, GOLD PLATING, .000030 [0.8 um] THICK
 CONTACT - BRASS, GOLD PLATING, .000030 [0.8 um] THICK
 INSULATOR - PEEK, NATURAL
2. ELECTRICAL:
 A. IMPEDANCE: 50 OHM
 B. FREQUENCY RANGE: DC - 6 GHz
 C. VSWR(RETURN LOSS): 1.10 (26.4 dB), MAX. DC-2GHz
 1.22 (20 dB), MAX. 2-6GHz
 D. DIELECTRIC WITHSTANDING VOLTAGE: 500 VRMS, MIN.
3. PHYSICAL:
 A. DURABILITY: 500 CYCLES MIN.
 B. ENGAGEMENT FORCE: 9 LB [40 N] MAX
 C. DISINGAGEMENT FORCE: 2 LB [8.8 N] MIN
 D. INNER CONTACT RETENTION FORCE: 1.5 LB [7 N] MIN
 E. TEMPERATURE RANGE: -65° C TO 165° C

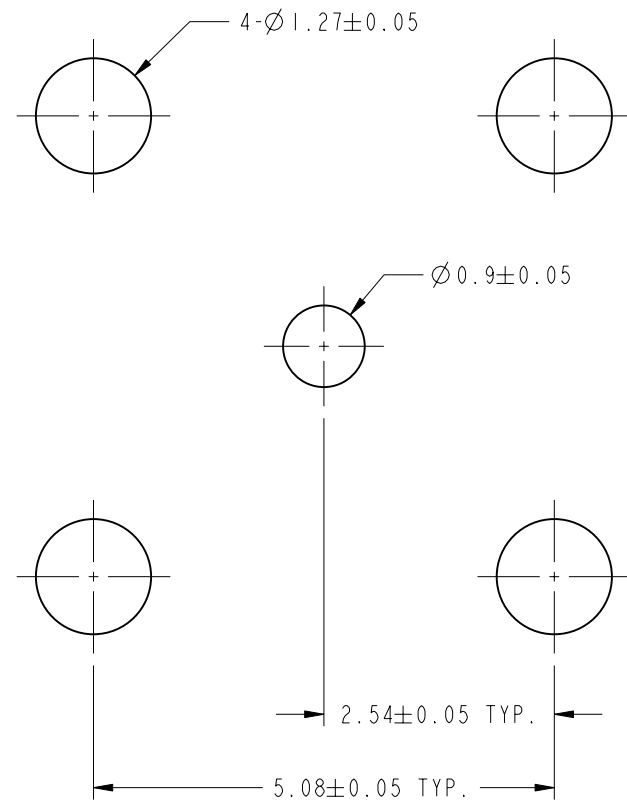
THIRD ANGLE PROJ.

REVISIONS

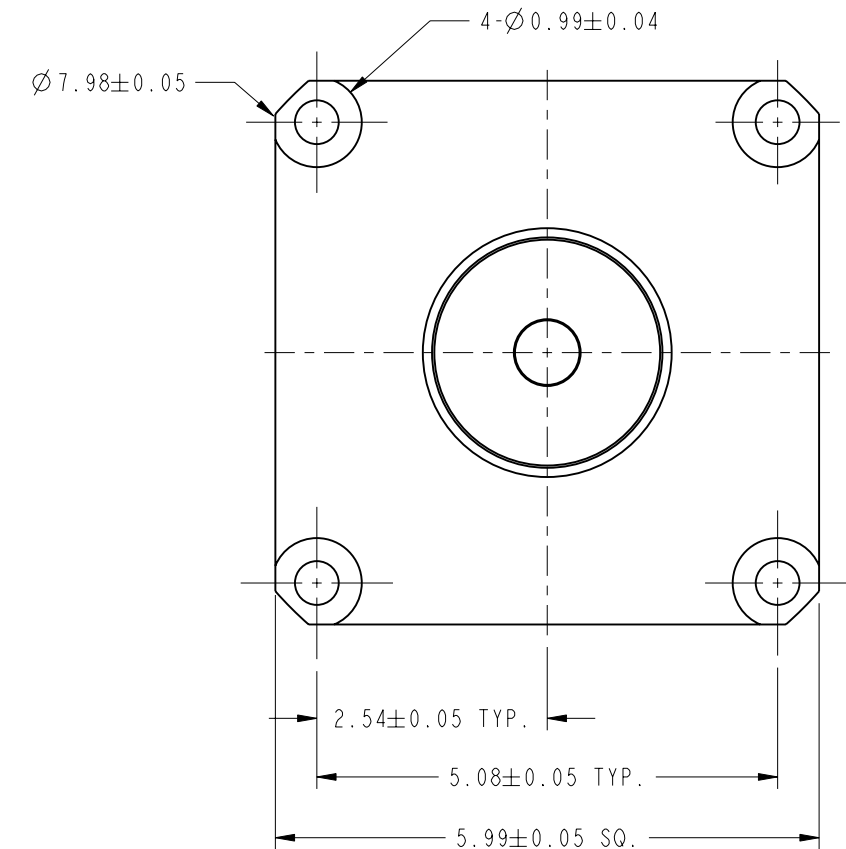
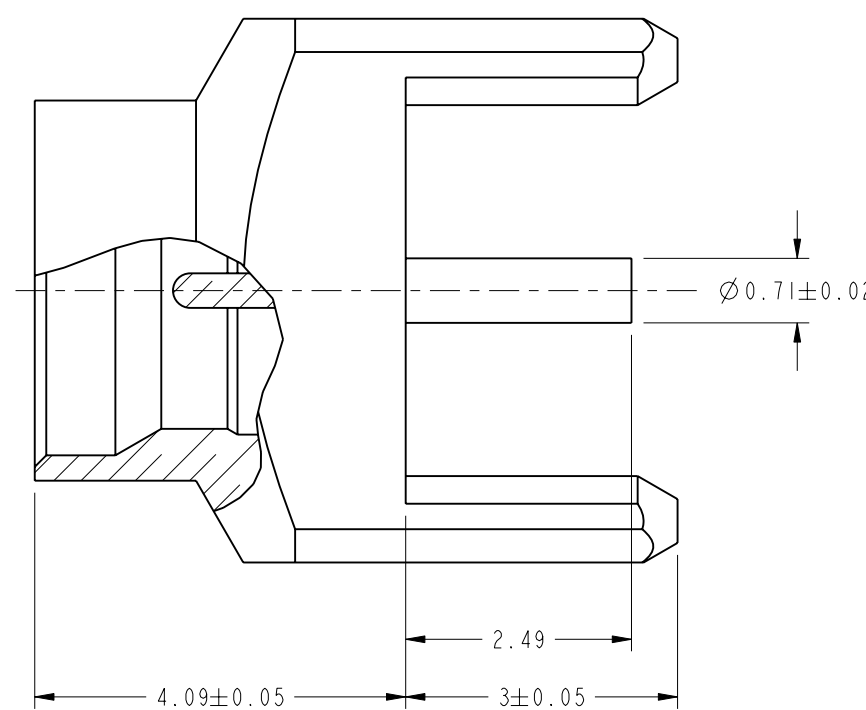
REV	DESCRIPTION	DATE	ECO	APPR
A	RELEASE TO MFG	3/2/05	45425	WAH
B	ADDED RECOMMENDED PCB\RD-DM10052601J1	01-Jun-10	48105	SH



SCALE 4.000



RECOMENDED PCB MOUNTING DIMENSIONS



CUSTOMER OUTLINE DRAWING

ALL OTHER SHEETS ARE FOR INTERNAL USE ONLY

UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN METRIC AND TOLERANCES ARE: <0.5mm ±0.05mm 0.5 - 6mm ±0.1mm 6 - 30mm ±0.2mm 30 - 120mm ±0.3mm ANGLES ±1°	MATERIAL	DRAWN J.CHENG ENGINEER S.HSIEH	DATE 01-Jun-10 DATE 9/21/04	TITLE SMP JACK PIN CONTACT PCB RECEPTACLE CATCHERS MIT SCALE: 12.0:1.0 SHEET 2 OF 2	Amphenol RF Danbury CT USA, Tainan, Taiwan, Shenzhen, China www.amphenolrf.com
	REFERENCE EAR # 1531 AND 615X-1732 CONFIGURATION LEVEL: Released	APPROVED S.HSIEH CAD FILE I:\SMP\SMP-MSLD-PCT	DATE 01-Jun-10 DWG SIZE B REV B		

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